

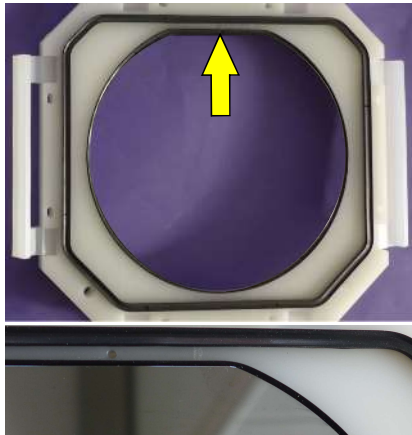
TRIO Plus

Wafer loading

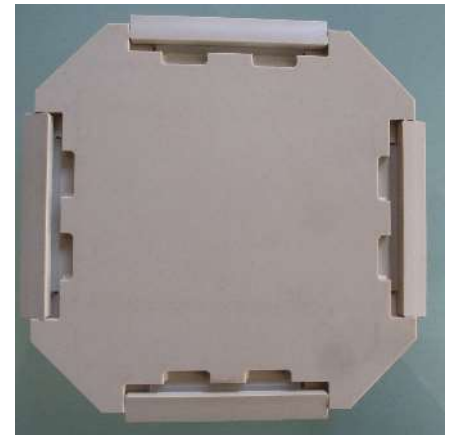
add the wafer
in the centre
of the inner sealing lip.

If the wafer thickness vary
to the standard thickness
a foil could be placed under the wafer

**Foil (0,1 / 0,2 / 0,5 mm)
available on request**

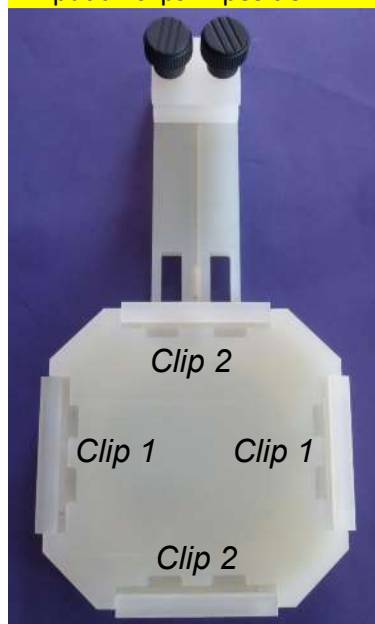


To extend the life time of
the sealing lips we recommend
not to close the clips
during no use time.



add the function plate

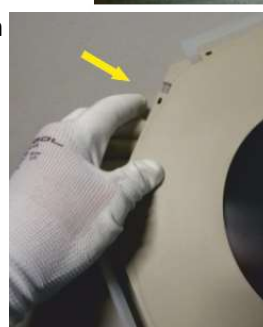
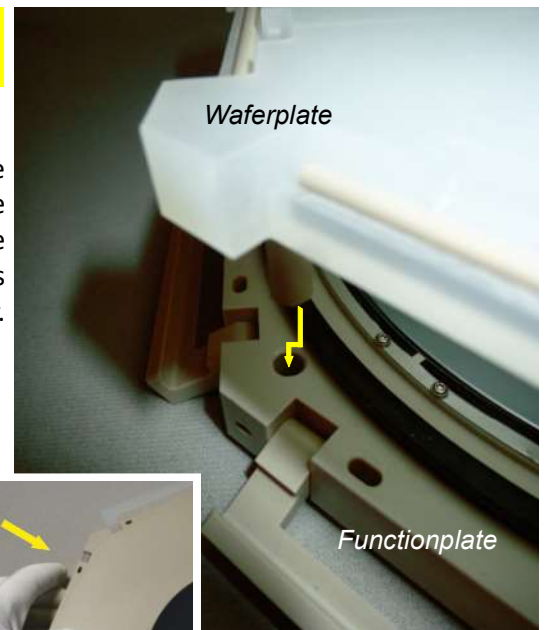
Prior closing
put all clips in position



please ensure prior the wafer
loading clean sealing lips

add the waferplate
with the pins above
the holes in the functionplate
and press it towards
the wafer.

please close always
the opposite clips
until you hear
the clips pushed in



Wafer unloading

add the „entclipser tool“ into the gap at the clip
and press/turn the tool.
The clip open.
Open the clips in opposite order.

Remove the waferplate straight upwards. The wafer could be removed.



Ensure prior the next loading clean sealing lips.